796 A	DCP # REV	
RELEASED	DESCRIPTION	REVISIONS
НО	DRAWN	DOC. NO
3/28/02 JWM 3/28/02 DJC	DATE	DOC. NO. SPC-F005 * Effective: 12/21/98 * DCP No: 680
MML	CHECKD	* Effect
3/28/02	CHECKD DATE APPRVD DATE	ive: 12/21/
DJC	APPRVD	98 * DC
3/28/02	DATE	P No: 680



Formulated to prolong tip life in the harsh soldering environments of rosin, no-clean and water soluble fluxes. Flux usage allows oxide build-up on tip, causing poor thermal transfer and dewetting of the tip surface. Use on standard tips.

			UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE FOR REFERENCE PURPOSES ONLY.				ALL STATEMENTS AND TECHNICAL INFORMATION CONTAINED HEREIN ARE BASED UPON INFORMATION ALL STATEMENTS WE BELLEK TO BE ACCURATE AND RELABLE. SINCE CONDITIONS OF USE ARE BEYOND OUR CONTROL, THE USERS SHALL DETERMINE THE SURFABILITY OF THE PRODUCT FOR THE INTENDED USE AND ASSUME ALL RISK AND LUGBLITY WHATSOEVER IN CONNECTION THEREWITH.	
	DANIEL CAREY	APPROVED BY:		JEFF MCVICKER	CHECKED BY:	HISHAM ODISH	DRAWN BY:	lusalamen All statements and Technical Information Contained Herein are based upon information amb/or tests we believe to be accupate and reluble. Since conditions of use are beyond our control, the user shall determine the sutrability of product for the intended use and assume all risk and lubility whatsoever in connection therewith.
	3/28/02	DAIE:	7	3/28/02	DATE:	3/28/02	DATE:	ON INFORMATION OF USE ARE RODUCT FOR THE N THEREWITH.
	SCALE: NTS U.O.M.: INCHES [mm] SHEET: 1 OF 1		ļ	>	SIZE	DRAWING TITLE:		
					SIZE DWG. NO.			
				471		1/2 Oz. LEAD FREE TI		SPC TECHNO
				10N69	ELECTRONIC FILE	EE TIP TINNER		HNOLOGY
			ON694.DWG		FILE			
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